

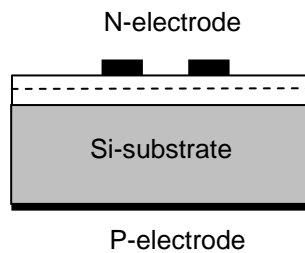
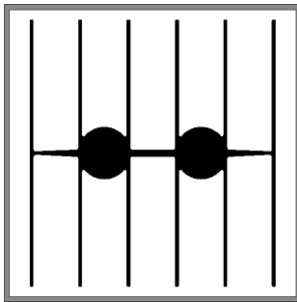
### > Mechanical Specification:

#### (1) Dimension

- Chip size: 28 mil x 28 mil ( $700\pm 25\ \mu\text{m}$  x  $700\pm 25\ \mu\text{m}$ )
- Thickness: 6.7 mil ( $170\pm 25\ \mu\text{m}$ )
- N bonding pad: 4.7 mil ( $120\pm 10\ \mu\text{m}$ )

#### (2) Metallization

- Topside N electrode (x2): Au alloy
- Backside P electrode: Au alloy



#### Features:

- High radiant flux
- Thin film structure
- Vertical electrode
- High driving current

#### Applications:

- Data Communication
- Surveillance

### > Electro-optical Characteristics at 25°C:

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	Vf1	If = 10 $\mu$ A	0.7	-	-	V
	Vf2	If = 350mA	-	1.5	1.9	V
Reverse Current	Ir	Vr = 10V	-	-	5.0	$\mu$ A
Peak Wavelength <sup>(1)</sup>	$\lambda_p$	If = 350mA	925	940	955	nm
Spectra Half-width	$\Delta\lambda$	If = 350mA	-	44	-	nm
Radiant flux <sup>(2)(3)</sup>	Po	H12	190	-	-	mW
		H13	220	-	-	

Note:

(1) Basically, the wavelength span is 30nm; however, customers' special requirements are also welcome.

(2) Customers' special requirements are also welcome.

(3) Radiant flux is measured by EPISTAR's equipment on bare chips.

## > Absolute Maximum Ratings:

Parameter	Symbol	Condition	Rating	Unit
Forward DC Current	If	Ta = 25°C	≤ 800	mA
Reverse Voltage	Vr	Ta = 25°C	≤ 10	V
Junction Temperature	Tj	-	≤ 115	°C
Storage Temperature	Tstg	Chip	-40 ~ +85	°C
		Chip-on-tape/storage	5 ~ 35	°C
		Chip-on-tape/transportation	-20 ~ +65	°C
Temperature during Packaging	-	-	280(<10sec)	°C

Note: Maximum ratings are package dependent. The above maximum ratings were determined using a Metal Core Printed Circuit Board (MCPCB) without an encapsulant. Stresses in excess of the absolute maximum ratings such as forward current and junction temperature may cause damage to the LED.

## > Characteristic Curves:

Fig.1 – Relative Radiant Flux Intensity vs. Forward Current

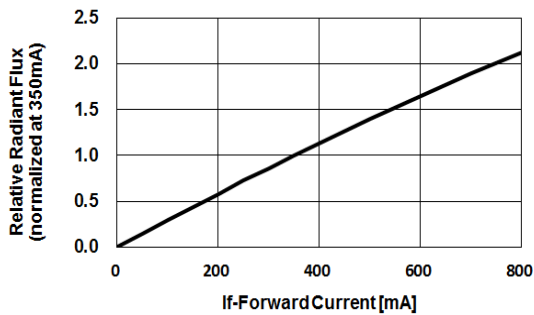


Fig.2 – Forward Current vs. Forward Voltage

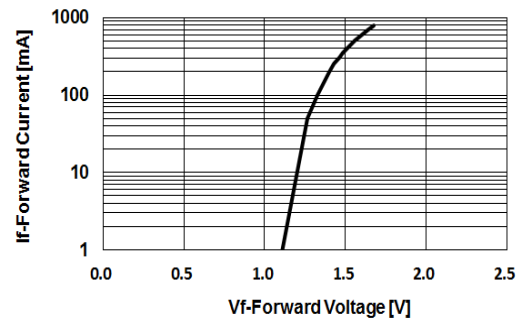


Fig.3 – Relative Radiant Flux (@350mA) vs. Ambient Temperature

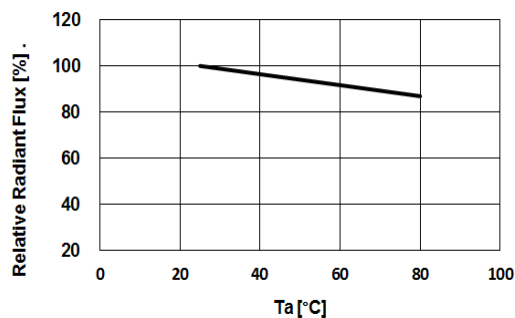


Fig.4 – Forward Voltage (@350mA) vs. Ambient Temperature

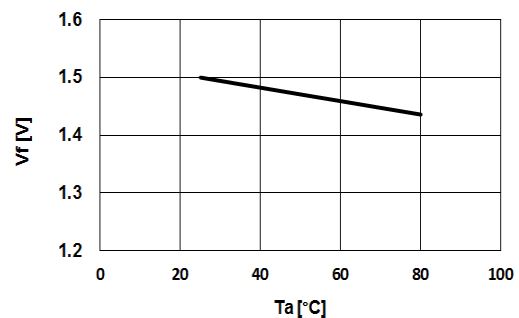


Fig.5 – Peak Wavelength (@350mA) vs. Ambient Temperature

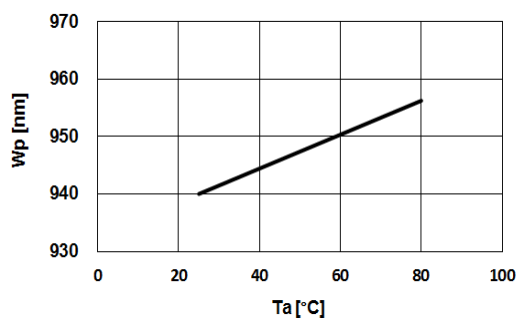


Fig.6 – Maximum Driving Forward DC Current vs. Ambient Temperature (De-rating based on Tj max. = 115°C)

